onsemi

Automotive 750 V, 800 A Dual Side Cooling Half-Bridge Power Module

VE-Trac[™] Dual NVG800A75L4DSC

Product Description

The NVG800A75L4DSC is part of a family of power modules with dual side cooling and compact footprints for Hybrid (HEV) and Electric Vehicle (EV) traction inverter application.

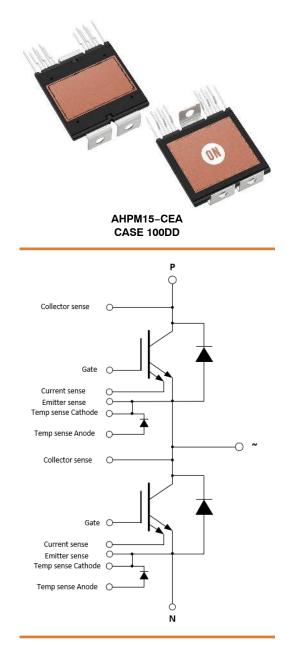
The module consists of two Field Stop 4 (FS4) 750 V Narrow Mesa IGBTs in a half-bridge configuration. The chipset utilizes the new narrow mesa IGBT technology in providing high current density and robust short circuit protection with higher blocking voltage to deliver outstanding performance in EV traction applications.

Features

- Dual-Side Cooling
- Integrated Chip Level Temperature and Current Sensor
- $T_{vj max} = 175^{\circ}C$ for Continuous Operation
- Ultra-low stray inductance
- Low V_{CESAT} and Switching Losses
- Automotive Grade FS4 & Fast Diode Chip Technologies
- 4.2 kV Isolated DBC Substrate
- AEC Qualified and PPAP Capable
- This Device is Pb-Free and is RoHS Compliant

Typical Applications

- Hybrid and Electric Vehicle Traction Inverter
- High Power DC–DC Converter



ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

PIN DESCRIPTION

Pin #	Pin	Pin Function Description	Pin Arrangement
1	Ν	Low Side Emitter	2
2	Р	High Side Collector	9
3	H/S COLLECTOR SENSE	High Side Collector Sense	3 0
4	H/S CURRENT SENSE	High Side Current Sense	
5	H/S EMITTER SENSE	High Side Emitter Sense	
6	H/S GATE	High Side Gate	4
7	H/S TEMP SENSE (CATHODE)	High Side Temp sense Diode Cathode	
8	H/S TEMP SENSE (ANODE)	High Side Temp sense Diode Anode	8 <u>9</u>
9	~	Phase Output	15 0
10	L/S CURRENT SENSE	Low Side Current Sense	
11	L/S EMITTER SENSE	Low Side Emitter Sense	
12	L/S GATE	Low Side Gate	
13	L/S TEMP SENSE (CATHODE)	Low Side Temp sense Diode Cathode	13 O
14	L/S TEMP SENSE (ANODE)	Low Side Temp sense Diode Anode	
15	L/S COLLECTOR SENSE	Low Side Collector Sense) ŭ

Materials

DBC Substrate: Al₂O₃ isolated substrate, basic isolation, and copper on both sides Lead Frame: Copper with Tin electro-plating

Flammability Information

All materials present in the power module meet UL flammability rating class 94V–0

MODULE CHARACTERISTICS

Symbol	Parameter	Rating	Unit		
T _{vj}	Continuous Operating Junction Temperature rang	Continuous Operating Junction Temperature range			
T _{STG}	Storage Temperature range			-40 to 125	°C
V _{ISO}	Isolation Voltage, DC, t = 1 s			4200	V
Creepage	Terminal to Terminal	Terminal to Terminal			mm
Clearance	Terminal to Terminal			3.4	mm
CTI	Comparative tracking index			>600	-
		Min	Тур	Max	
L _{sCE}	Stray Inductance			8	nH
R _{CC'+EE'}	Module lead resistance, terminals - chip			0.15	mΩ
G	Module weight			75	g
М	M4 screws for module terminals			2.2	Nm

ABSOLUTE MAXIMUM RATINGS (T_{VJ} = 25°C, Unless Otherwise Specified)

Symbol	Parameter	Rating	Unit				
IGBT							
V _{CES}	Collector to Emitter Voltage	750	V				
V _{GES}	V _{GES} Gate to Emitter Voltage I _{CN} Implemented Collector Current		V				
I _{CN}			A				
$I_{C \text{ nom}}$ Continuous DC Collector Current, $Tv_{Jmax} = 175^{\circ}C$, $T_F = 65^{\circ}C$, ref. heatsink		550 (1)	A				
I _{CRM}	Pulsed Collector Current @ VGE = 15 V, t _p = 1 ms	1600	А				

Diode

V _{RRM}	Repetitive peak reverse voltage	750	V
I _{FN}	Implemented Forward Current	800	A
١ _F	Continuous Forward Current, $Tv_{Jmax} = 175^{\circ}C$, $T_F = 65^{\circ}C$, ref. heatsink	420 (1)	А
I _{FRM}	I _{FRM} Repetitive Peak Forward Current, t _p = 1 ms		А
l ² t value	Surge current capability, V _R = 0 V, t _p = 10 ms, $Tv_J = 150^{\circ}C$ $T_{VJ} = 175^{\circ}C$	20000 18000	A ² s

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Verified by characterization, not by test.

THERMAL CHARACTERISTICS (Verified by characterization, not by test.)

Symbol	Parameter	Min	Тур	Max	Unit
IGBT.R _{th,J-C}	Effective Rth, Junction to Case ⁽²⁾		0.05	0.07	°C/W
IGBT.R _{th,J-F}	Effective Rth, Junction to Fluid, $\lambda_{TIM} = 6 \text{ W/m-K}$, F = 660 N 10 L/min, 65°C, 50/50 EGW, Ref. Heatsink		0.14		°C/W
Diode.R _{th,J-C}	Effective Rth, Junction to Case ⁽²⁾		0.08	0.10	°C/W
Diode.R _{th,J-F}	Effective Rth, Junction to Fluid, $\lambda_{TIM} = 6 \text{ W/m-K}$, F = 660 N 10 L/min, 65°C, 50/50 EGW, Ref. Heatsink		0.21		°C/W

2. For the measurement point of case temperature (Tc), DBC discoloration, picker circle print is allowed, please refer to the VE-Trac Dual assembly guide for additional details about acceptable DBC surface finish.

CHARACTERISTICS OF IGBT (Tvj = 25°C, Unless Otherwise Specified)

	Parameters	Conditions	Min	Тур	Max	Unit
V _{CESAT} Collector to Emitter Saturation Voltage (Terminal)		V_{GE} = 15 V, I _C = 600 A, Tv _J = 25°C Tv _J = 150°C Tv _J = 175°C	-	1.30 1.42 1.45	1.55	V
		$\label{eq:VGE} \begin{array}{l} V_{GE} = 15 \; V, \; I_C = 800 \; A, \; Tv_J = 25^\circ C \\ Tv_J = 150^\circ C \\ Tv_J = 175^\circ C \end{array}$		1.44 1.64 1.68		
I _{CES}	Collector to Emitter Leakage Current	$V_{GE} = 0, V_{CE} = 750 \text{ V} \qquad Tv_J = 25^{\circ}\text{C}$ $Tv_J = 175^{\circ}\text{C}$	-	- 8	1 -	mA mA
I _{GES}	Gate – Emitter Leakage Current	V_{CE} = 0, V_{GE} = ± 20 V	-	-	400	nA
V _{th}	Threshold Voltage	$V_{CE=} V_{GE}$, $I_C = 500 \text{ mA}$	4.6	5.5	6.2	V
Q_{G}	Total Gate Charge	$V_{GE=}$ -8 to 15 V, V_{CE} = 400 V	_	1.9	-	μC
R _{Gint}	Internal gate resistance		_	2	_	Ω
C _{ies}	Input Capacitance	$V_{CE} = 30 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	_	48	_	nF
C _{oes}	Output Capacitance	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	_	1.37	_	nF
C _{res}	Reverse Transfer Capacitance	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	_	0.15	_	nF
T _{d.on}	Turn on delay, inductive load	$\begin{split} & I_{C} = 600 \; A, V_{CE} = 400 \; V & T_{VJ} = 25^{\circ}C \\ & V_{GE} = +15/-8 \; V & T_{VJ} = 150^{\circ}C \\ & Rg.on = 4.7 \; \Omega & T_{VJ} = 175^{\circ}C \end{split}$	_	253 283 287	-	ns
T _r	Rise time, inductive load	$\begin{split} & I_{C} = 600 \; A, \; V_{CE} = 400 \; V & Tv_{J} = 25^\circ C \\ & V_{GE} = +15/-8 \; V & Tv_{J} = 150^\circ C \\ & Rg.on = 4.7 \; \Omega & Tv_{J} = 175^\circ C \end{split}$	_	94 112 117	-	ns
T _{d.off}	Turn off delay, inductive load		-	760 790 800	-	ns
T _f	Fall time, inductive load		-	95 140 153	-	ns
E _{ON}	Turn-On Switching Loss (including diode reverse recovery loss)	$\begin{array}{l} I_{C}=600 \; \text{A}, \; V_{CE}=400 \; \text{V}, \; V_{GE}=+15/-8 \; \text{V}, \\ Ls=20 \; \text{nH}, \; \text{Rg.on}=4,7 \; \Omega \\ \text{di/dt} \; (\text{Tv}_{J}=25^{\circ}\text{C})=5.13 \; \text{A/ns} \\ \text{di/dt} \; (\text{Tv}_{J}=175^{\circ}\text{C})=4.11 \; \text{A/ns} \end{array}$	_		-	mJ
		Tv _J = 25°C Tv _J = 150°C Tv _J = 175°C		22.41 33.30 36.35		
E _{OFF}	Turn–Off Switching Loss	$ \begin{array}{l} I_{C} = 600 \text{ A}, $	_		_	mJ
		$Tv_{J} = 25^{\circ}C$ $Tv_{J} = 150^{\circ}C$ $Tv_{J} = 175^{\circ}C$		27.22 37.19 39.09		
E _{SC}	Minimum Short Circuit Energy Withstand	V_{GE} = 15 V, V_{CC} = 400 V Tv _J = 25°C Tv _J = 175°C	5 7.5			J

	Parameters	Conditions	i	Min	Тур	Max	Unit
V _F	Diode Forward Voltage (Terminal)	V _{GE} = 0 V, I _C = 600 A,	Tv _J = 25°C Tv _J = 150°C Tv _J = 175°C	-	1.40 1.30 1.30	1.60	V
		V _{GE} = 0 V, I _C = 800 A,	Tv _J = 25°C Tv _J = 150°C Tv _J = 175°C		1.48 1.44 1.42		
Err	Reverse Recovery Energy	I_F = 600 A, V_R = 400 V, V_{GE} Rg.on = 4.7 Ω , –di/dt = 3.1		_	4.09 10.93 11.92	_	mJ
Q _{RR}	Recovered Charge	I_F = 600 A, V_R = 400 V, V_{GE} Rg.on = 4.7 Ω , –di/dt = 3.1	z = -8 V, 2 A/ns (175°C) Tv _J = 25°C Tv _J = 150°C Tv _J = 175°C	_	18.70 44.48 48.40	-	μC
lrr	Peak Reverse Recovery Current	I_F = 600 A, V_R = 400 V, V_{GE} Rg.on = 4.7 Ω , –di/dt = 3.1		_	248 331 337	_	A

CHARACTERISTICS OF INVERSE DIODE (T_{VJ} = 25°C, Unless Otherwise Specified)

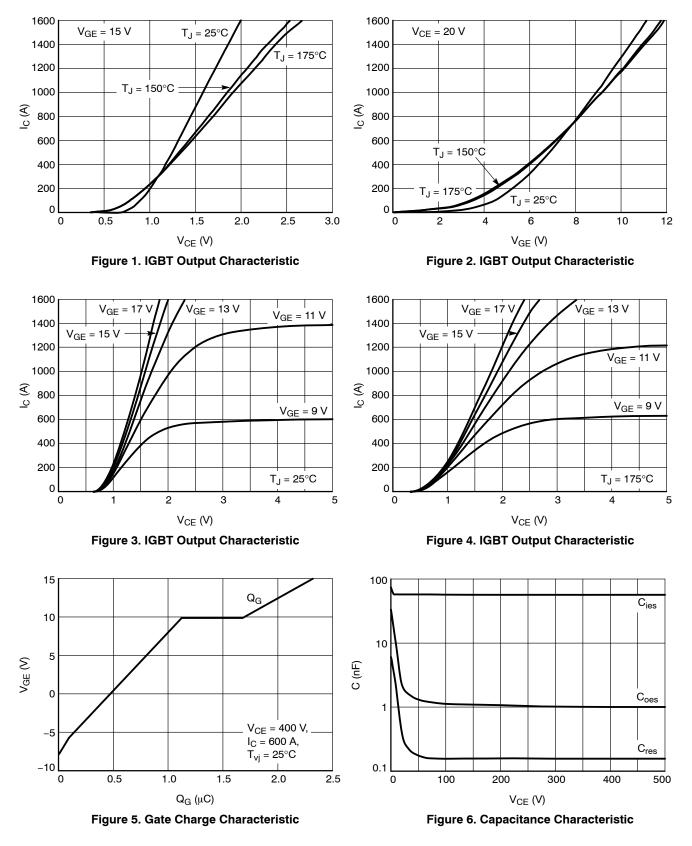
SENSOR CHARACTERISTICS (T_{VJ} = 25°C, Unless Otherwise Specified)

Parameters		Parameters Conditions	tions	Min	Тур	Max	Unit
T _{sense}	Temperature sense	I _F = 1 mA,	$Tv_J = -40^{\circ}C$ $Tv_J = 25^{\circ}C$ $Tv_J = 150^{\circ}C$ $Tv_J = 175^{\circ}C$	2.46 ⁽³⁾	2.96 2.54 1.76 1.61	2.60 ⁽³⁾	V
I _{sense}	Current sense	R _{shunt} = 5 Ω	I _C = 1600 A I _C = 800 A I _C = 100 A		379 200 43.0		mV
		R_{shunt} = 20 Ω	I _C = 1600 A I _C = 800 A I _C = 100 A		644 351 94.0		

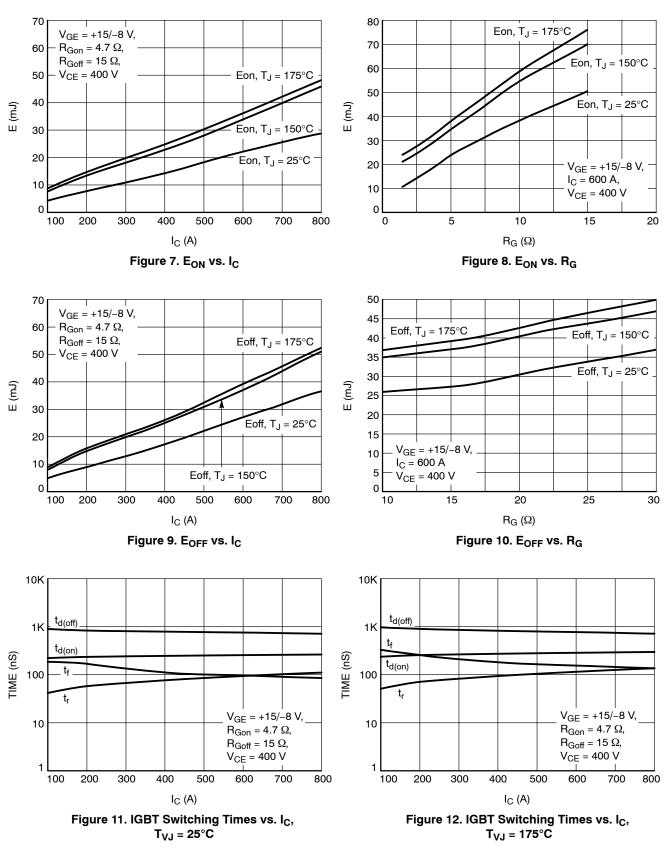
3. Measured at chip level

ORDERING INFORMATION

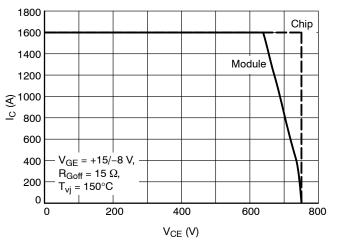
Part Number	Device Marking	Package	Shipping
NVG800A75L4DSC	N875DSC	AHPM15-CEA (Pb-Free)	6 Units / Tube



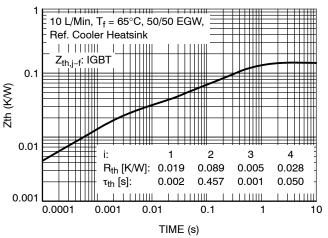
TYPICAL CHARACTERISTICS



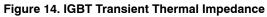
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS







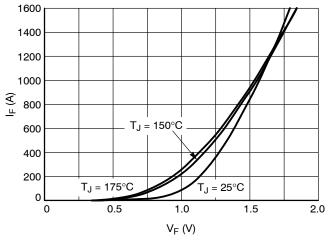


Figure 15. Diode Forward Characteristic

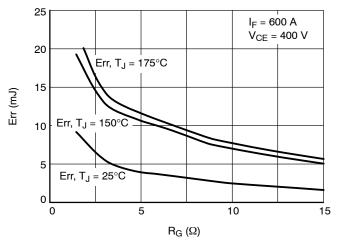


Figure 17. Diode Switching Losses vs. $\rm R_{G}$

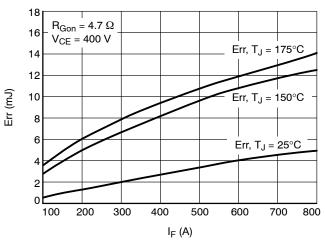
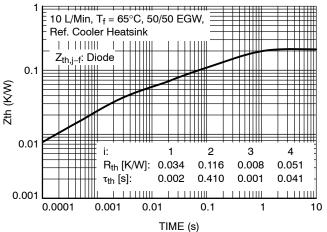
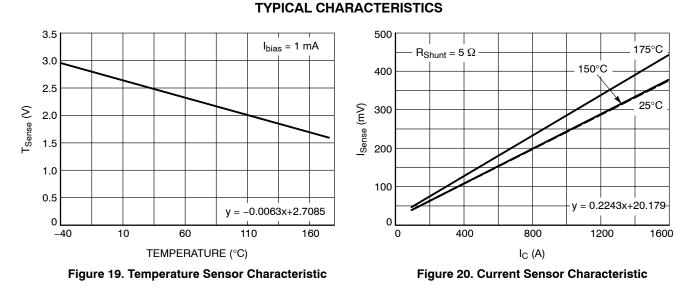


Figure 16. Diode Switching Losses vs. IF







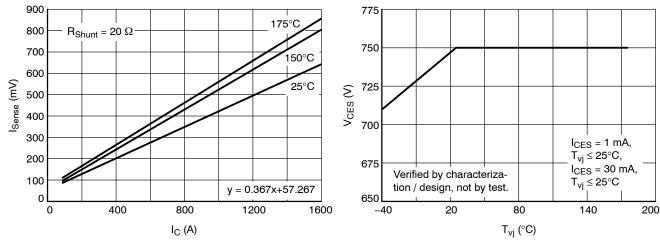


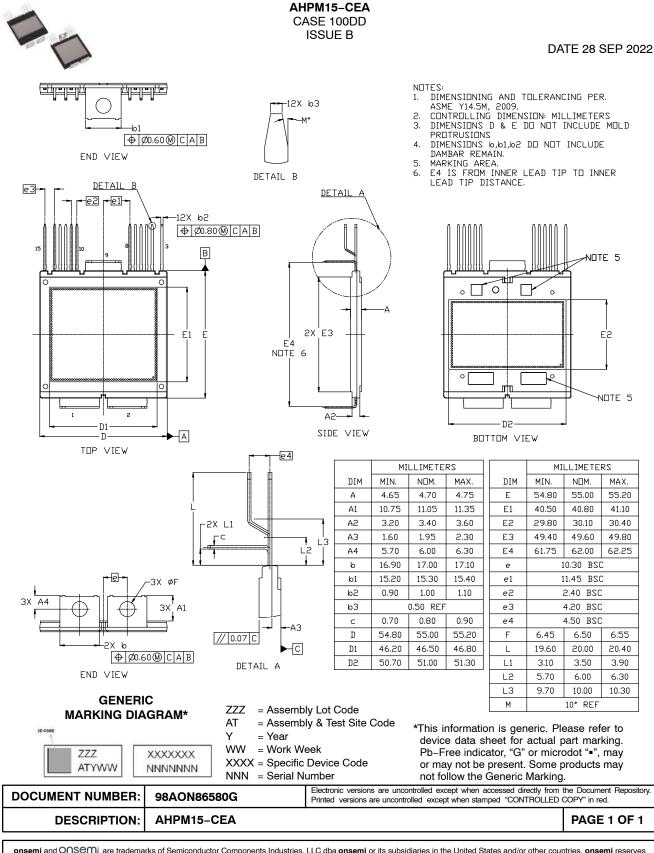
Figure 21. Current Sensor Characteristic

Figure 22. Maximum Allowed V_{CE}

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